2SK322

Silicon N-Channel Junction FET

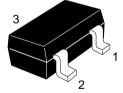
HITACHI

Application

HF wide band amplifier

Outline

MPAK



- 1. Drain
- 2. Source
- 3. Gate



2SK322

Absolute Maximum Ratings ($Ta = 25^{\circ}C$)

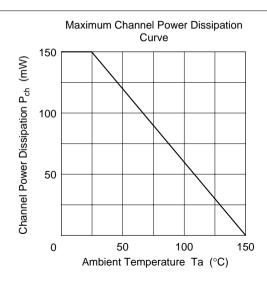
Item	Symbol	Ratings	Unit
Gate to drain voltage	V_{GDO}	–15	V
Gate to source voltage	$V_{\rm GSO}$	–15	V
Drain current	I _D	50	mA
Gate current	I _G	5	mA
Channel power dissipation	Pch	150	mW
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

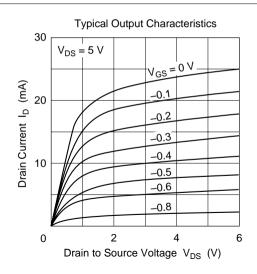
Electrical Characteristics ($Ta = 25^{\circ}C$)

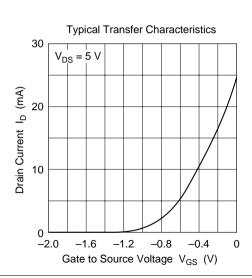
Item	Symbol	Min	Тур	Max	Unit	Test conditions
Gate to drain breakdown voltage	$V_{(BR)GDO}$	-15	_	_	V	$I_{G} = -100 \ \mu A$
Gate to source breakdown voltage	$V_{(BR)GSO}$	-15	_	_	V	$I_G = -100 \mu A$
Gate cutoff current	$I_{\rm GSS}$	_	_	-10	nA	$V_{GS} = -7 \text{ V}, V_{DS} = 0$
Drain current	I _{DSS} *1	5	_	50	mA	$V_{DS} = 5 \text{ V}, V_{GS} = 0 \text{ (pulse)}$
Gate to source cutoff voltage	$V_{GS(off)}$	_	_	-3.0	V	$V_{DS} = 5 \text{ V}, I_{D} = 100 \mu\text{A}$
Forward transfer admittance	$ y_{fs} $	25	45	_	mS	$V_{DS} = 5 \text{ V}, V_{GS} = 0, f = 1 \text{ kHz}$

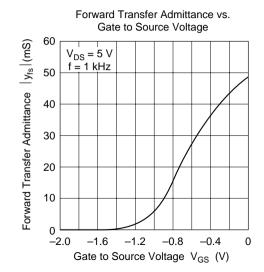
Note: 1. The 2SK322 is grouped by I_{DSS} as follows.

Grade	Р	Q	R	S	Т
Mark	WP	WQ	WR	WS	WT
I _{DSS}	5 to 16	14 to 24	20 to 32	28 to 42	36 to 50

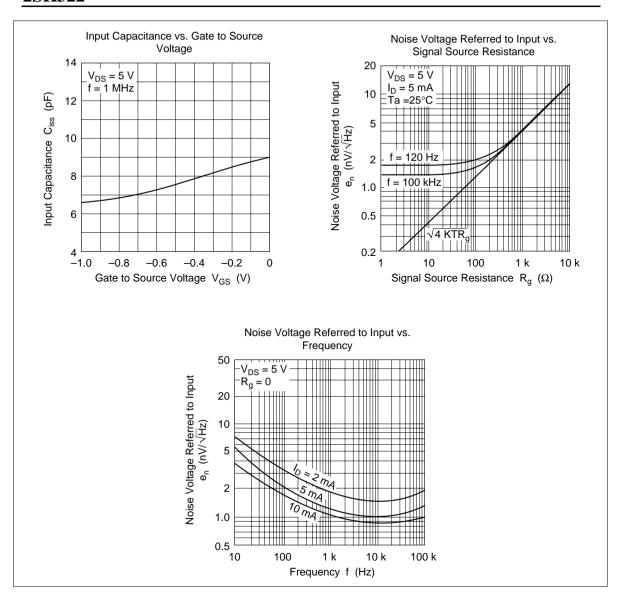




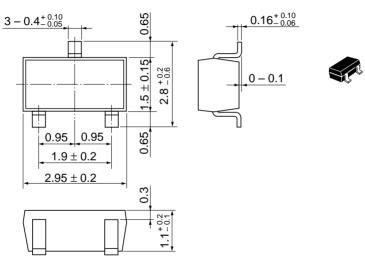




2SK322



Unit: mm



Hitachi Code	MPAK
JEDEC	_
EIAJ	Conforms
Weight (reference value)	0.011 g

Cautions

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